

# LIGHT EMITTING DIODE SPECIFICATION

DESCRIPTION: E6QYDD1204-PRA

REVISION: V2.2

ISSUE DATE: 2019-01-18

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#### **Features**:

- Long operating life
- •Low Power Consumption
- ●Low voltage DC operated
- ●RoHS Compliant

# **Application:**

- Position sensor
- •Infrared applied system
- Optoelectronic switch
- Miniature switch
- Counters and sorter



Part Number	umber Dice Material Emitted Color		Lens Color	
E6QYDD1204-PRA	Silicon	Phototransistor	Black	

### Electro-Optical Characteristics(Ta=25°C, @20mA)

Parameter	Symbol	Min.	Тур.	Max.	Unit	<b>Test Condition</b>	
Collector-Emitter Breakdown Voltage	$BV_{CEO}$	30	-	-	٧	I <sub>C</sub> =100μA,Ee=0mW/cm <sup>2</sup>	
Emitter-Collector Breakdown Voltage	BV <sub>ECO</sub>	5	-	-	V	I <sub>C</sub> =100μA,Ee=0mW/cm <sup>2</sup>	
Collector-Emitter Saturation Voltage	V <sub>CE</sub> (sat)	-	-	0.4	V	I <sub>C</sub> =100μA,Ee=0mW/cm <sup>2</sup>	
Collector Dark Current	ICEO	-	-	100	nA	IE=20μA, Ee=0mW/cm²	
Rise Time	tr	-	15	-	μS	$V_{CE}$ =5 $VI_{C}$ =1 $mA$ , $R_{L}$ =1000 $\Omega$	
Fall Time	t <sub>f</sub>	-	15	-	μS	V <sub>CE</sub> =5V I <sub>C</sub> =1mA,R <sub>L</sub> =1000Ω	
On State Collector Current	Ic(ON)	0.7	-	-	mA	Ee=0.555mW/cm <sup>2</sup> ,V <sub>CE</sub> =5V	
Wavelength Of Peak Sensitivity	λР	-	940	-	nm	-	
Rang Of Spectral Bandwidth	λ0.5	760	-	1100	nm	m -	

### Absolute Maximum Ratings(Ta=25°C)

Parameter Parame	Symbol	Max.	Unit
Power Dissipation	PD	70	mW
Collector-Emitter Voltage	VCEO	30	V
Emitter-Collector-Voltage	VECO	5	V
Operating Temperature Range	Topr	-40to+90	$^{\circ}$
Storage Temperature Range	Tstg	-40to+90	${\mathbb C}$
Reflow Soldering	Tsld	260°C for 5 secs	



### **Optical & Electrical Characteristics**

Fig.1Collector Power Dissipation vs.

Ambient Temperature

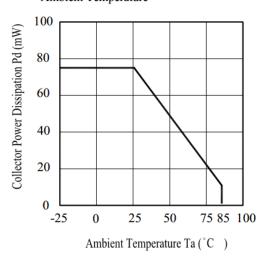


Fig.2 Spectral Sensitivity

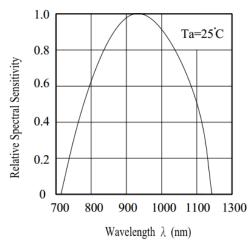


Fig.3 Relative Collector Current vs.

Ambient Temperature

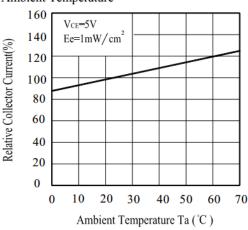


Fig.4 Collector Current vs.

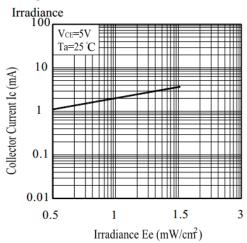


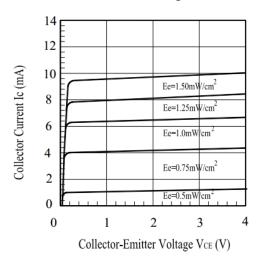
Fig.5 Collector Dark Current vs.
Ambient Temperature

10<sup>-6</sup>
5
VCE=20V

10<sup>-7</sup>
5
10<sup>-8</sup>
5
0
2
10<sup>-9</sup>
10<sup>-9</sup>
0
25
50
75
100

Ambient Temperature Ta (°C)

Fig.6 Collector Current vs.
Collector-Emitter Voltage



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# **Reliability Test Items And Conditions**

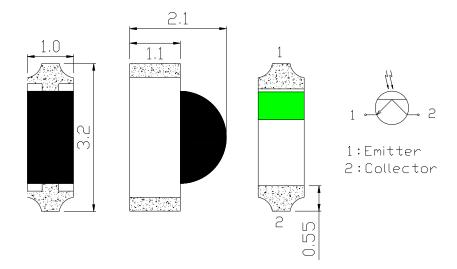
Test Items	Reference	<b>Test Conditions</b>	Time	Quantity	Criterion
Thermal Shock	MIL-STD-202G	-40°C (30min) -100°C (30min)	100 Cycles	22	0/22
Temperature And Humidity Cyclic	JEITA ED-4701 200 203	-10℃~65℃; 0%~90%RH	10cycles	22	0/22
High Temperature Storage	JEITA ED -4071 200 201	Ta=100°C	1000H	22	0/22
Low Temperature Storage	JEITA ED -4071 200 202	Ta=-40°C	1000H	22	0/22
High Temperature High Humidity Storage	JEITA ED -4071 100 103	Ta=60˚ℂ ; RH=90%	1000H	22	0/22
High Temperature Life Test	JESD22-A108D	Ta=80 ℃	1000H	22	0/22
Life Test	JESD22-A108D	Ta=25 ℃	1000H	22	0/22
Resistance to Sodering Heat	GB/T 4937, II , 2.2&2.3	Tsol*=(240±5) °C 10secs	2 times	22	0/22

# **Criteria For Judging Damage**

Test Items	Symbol	<b>Test Conditions</b>	Criteria For Judging Damage
Forward Voltage	$V_{F}$	I <sub>F</sub> =I <sub>FT</sub>	Initial Data±10%
Recerse Current	I <sub>R</sub>	V <sub>R</sub> =5V	I <sub>R</sub> ≤10uA
Luminous Intensity	IV	I <sub>F</sub> =I <sub>FT</sub>	Average I <sub>V</sub> degradation≤30%; Single LED I <sub>V</sub> degradation≤50%
Resistance to Soldering Heat	-	-	Meterial without internal cracks,no meterial between stripped,no deaded light



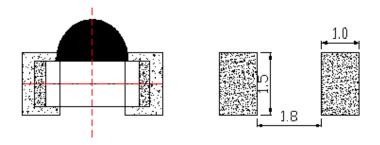
# **Product size (Unit:mm)**



#### NOTES:

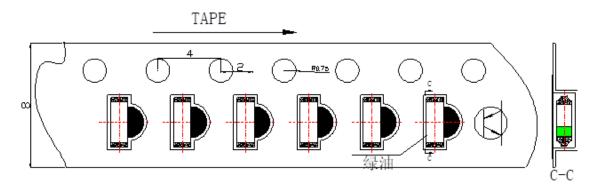
- 1. All dimensions are in millimeters (inches)
- 2. Tolerances are  $\pm 0.2$ mm (0.008inch) unless otherwise noted

# Recommended Soldering Pad Design (Unit:mm)



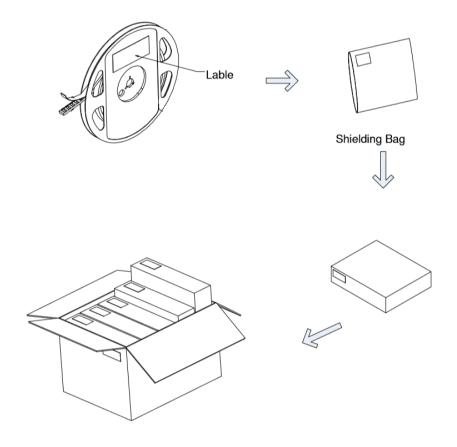
# Taping and package Spec

●Tape Specification:3,000pcs Per Reel





# **Packaging**



### LabelStyle

EKINGLUX OPTOELECTRONICS(SHANGHAI) CO.,LTD

TEL:86 21 59909181

Sales@ekingluxs.com

P/N:XXXXXXXXXXXXXXXXX

Emitting Color: XXXX

HUE: XXX-XXX nm

ROHS PO

IV: XXX-XXX mcd **example** 

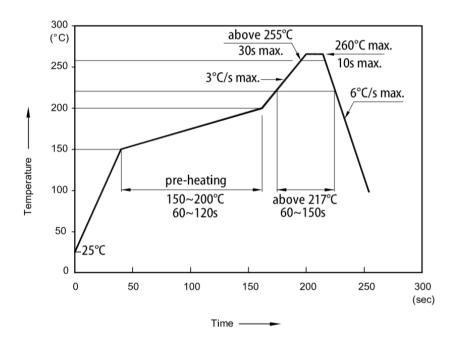
VF: XX-XX V BIN Code: XX

QTY: XX PCS DATE: XXXX/XX/XX

LOT NO:XXXXXXX



### **Reflow Soldering Instructions**



- 1. Don't cause stress to the LEDs while it is exposed to high temperature.
- 2. The maximum number of reflow soldering passes is 2 times.
- 3. Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.



#### **Precautions**

#### 1. Storage:

- •Moisture proof and anti-electrostatic package with moisture absorbent material is used, to keep moisture to aminimum.
- ullet Before opening the package, the product should be kept at 30  $^{\circ}$ C or less and humidity less than 60% RH, and beused within a year.
- •After opening the package, the product should be stored at 30 °C or less and humidity less than 10%RH. It is recommended that the product be operated at the workshop condition of 30 °C or less and humidity less than 60%RH.
- •If the moisture absorbent material has fade away or the LEDs have exceeded the storage time, baking treatment should be performed based on the following condition: (70±5)°C for 24 hours.

#### 2. Static Electricity:

Static electricity or surge voltage damages the LEDs. Damaged LEDs will show some unusual characteristic such as the forward voltage becomes lower, or the LEDs do not light at the low current. even not light.

All devices, equipment and machinery must be properly grounded. At the same time, it is recommended that wrist bands or anti-electrostatic gloves, anti-electrostatic containers be used when dealing with the LEDs.

#### 3. Vulcanization:

LED curing is due to sulfur being in bracket and the +1 price of silver in the chemical reaction generated Ag2S in the process. It will lead to the capacity of reflecting of silver layer reducing, light color temperature drift and serious decline ,seriously affecting the performance of the product. So we should take corresponding measures to avioding vulcanization, such as to avoid using sulphur volatile substances and keeping away from high sulphur content of the material.

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